INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 Feb 12 IC24 Data Handbook 1998 Apr 20





74LV10

FEATURES

- Optimized for Low Voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C.$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C.$
- Output capability: standard
- I_{CC} category: SSI

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

DESCRIPTION

The 74LV10 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT10.

The 74LV10 provides the 3-input NAND function.

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay nA, nB, nC to nY	C _L = 15 pF; V _{CC} = 3.3 V	9	ns
Cl	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per gate	See Notes 1 and 2	12	pF

NOTES:

NOTES: 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where: $f_i = \text{input frequency in MHz}$; $C_L = \text{output load capacitance in pF}$; $f_o = \text{output frequency in MHz}$; $V_{CC} = \text{supply voltage in V}$; $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of the outputs}$. 2. The condition is $V_I = \text{GND to } V_{CC}$

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	–40°C to +125°C	74LV10 N	74LV10 N	SOT27-1
14-Pin Plastic SO	–40°C to +125°C	74LV10 D	74LV10 D	SOT108-1
14-Pin Plastic SSOP Type II	–40°C to +125°C	74LV10 DB	74LV10 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV10 PW	74LV10PW DH	SOT402-1

PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 9	1A – 3A	Data inputs
2, 4, 10	1B – 3B	Data inputs
7	GND	Ground (0 V)
12, 6, 8	1Y – 3Y	Data outputs
13, 5, 11	1C – 3C	Data inputs
14	V _{CC}	Positive supply voltage

FUNCTION TABLE

	INPUTS		OUTPUTS
nA	nB	nY	
L	L	L	н
L	L	Н	н
L	Н	L	н
L	н	н	Н
н	L	L	Н
н	L	н	Н
н	Н	L	Н
н	н	н	L

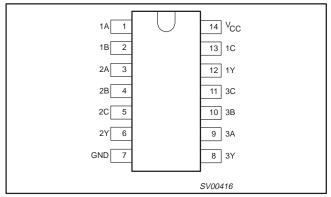
NOTES:

H = HIGH voltage level

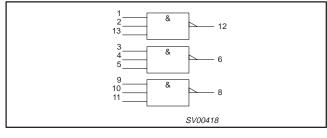
L = LOW voltage level

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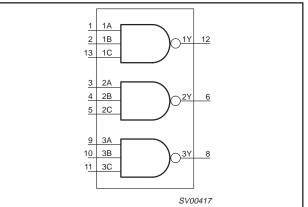
PIN CONFIGURATION



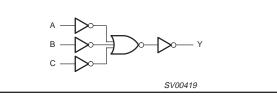
LOGIC SYMBOL (IEEE/IEC)



LOGIC SYMBOL



LOGIC DIAGRAM (ONE GATE)



RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{CC}	DC supply voltage	See Note1	1.0	3.3	3.6	V
VI	Input voltage		0	-	V _{CC}	V
Vo	Output voltage		0	-	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.0V \text{ to } 2.0V$ $V_{CC} = 2.0V \text{ to } 2.7V$ $V_{CC} = 2.7V \text{ to } 3.6V$	- - -	- - -	500 200 100	ns/V

NOTE:

1. The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 3.6V.

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
$\pm I_{IK}$	DC input diode current	$V_{\rm I} < -0.5 \text{ or } V_{\rm I} > V_{\rm CC} + 0.5 V$	20	mA
$\pm I_{OK}$	DC output diode current	$V_{\rm O}$ < -0.5 or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5V	50	mA
$\pm I_{O}$	DC output source or sink current – standard outputs	$-0.5V < V_{O} < V_{CC} + 0.5V$	25	mA
$^{\pm I_{GND},}_{\pm I_{CC}}$	DC V _{CC} or GND current for types with – standard outputs		50	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

					LIMITS				
SYMBOL	PARAMETER	TEST CONDITIONS	-4	0°C to +8	5°C	-40°C to	o +125°C		
			MIN	TYP ¹	MAX	MIN	MAX		
		V _{CC} = 1.2 V	0.9			0.9			
V_{IH}	HIGH level Input voltage	$V_{CC} = 2.0 V$	1.4			1.4		V	
	Voltago	V _{CC} = 2.7 to 3.6 V	2.0			2.0		1	
		V _{CC} = 1.2 V			0.3		0.3		
VIL	LOW level Input voltage	V _{CC} = 2.0 V			0.6		0.6	V	
	Vollage	V _{CC} = 2.7 to 3.6 V			0.8		0.8	1	
		$V_{CC} = 1.2 \text{ V}; \text{ V}_{I} = \text{V}_{IH} \text{ or } \text{V}_{IL;} - \text{I}_{O} = 100 \mu \text{A}$		1.2					
	HIGH level output	$V_{CC} = 2.0 \text{ V}; \text{ V}_{I} = \text{V}_{IH} \text{ or } \text{V}_{IL;} - \text{I}_{O} = 100 \mu \text{A}$	1.8	2.0		1.8			
V _{OH} voltage; all outputs	$V_{CC} = 2.7 \text{ V}; \text{ V}_{I} = \text{V}_{IH} \text{ or } \text{V}_{IL;} - \text{I}_{O} = 100 \mu \text{A}$	2.5	2.7		2.5				
		$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = \text{V}_{IH} \text{ or } \text{V}_{IL;} - \text{I}_{O} = 100 \mu \text{A}$	2.8	3.0		2.8			
V _{OH}	HIGH level output voltage; STANDARD outputs	$V_{CC} = 3.0 \text{ V}; \text{ V}_{\text{I}} = \text{V}_{\text{IH}} \text{ or } \text{V}_{\text{IL};} - \text{I}_{\text{O}} = 6\text{mA}$	2.40	2.82		2.20		V	
		V_{CC} = 1.2 V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0					
V	LOW level output	V_{CC} = 2.0 V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2		
V _{OL}	voltage; all outputs	V_{CC} = 2.7 V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2		
		V_{CC} = 3.0 V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2	1	
V _{OL}	LOW level output voltage; STANDARD outputs	V_{CC} = 3.0 V; V_{I} = V_{IH} or V_{IL} ; I_{O} = 6mA		0.25	0.40		0.50	V	
I	Input leakage current	$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = V_{CC} \text{ or GND}$			1.0		1.0	μA	
I _{CC}	Quiescent supply current; SSI	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		40	μA	

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DC ELECTRICAL CHARACTERISTICS (Continued)

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	o +125°C	UNIT
			MIN	TYP ¹	MAX	MIN	MAX	
ΔI _{CC}	Additional quiescent supply current per input	V_{CC} = 2.7 V to 3.6 V; V _I = V _{CC} – 0.6 V			500		850	μΑ

NOTE:

1. All typical values are measured at $T_{amb} = 25^{\circ}C$.

AC CHARACTERISTICS

GND = 0V; $t_r = t_f \le 2.5 \text{ns}$; $C_L = 50 \text{pF}$; $R_L = 1 \text{K}\Omega$

		WAVEFORM	CONDITION		LIMITS					
SYMBOL	PARAMETER		CONDITION		40 to +85 °	С	–40 to +125 °C		UNIT	
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX		
		Figure 1, 2	1.2		55				ns	
•	Propagation delay nA, nB, nC to nY		2.0		19	36		44		
t _{PHL/PLH}	nA, nB, nC to nY		2.7		14	26		33		
			3.0 to 3.6		10 ²	21		26		

NOTES:

1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^{\circ}C$.

2. Typical values are measured at V_{CC} = 3.3 V.

AC WAVEFORMS

 $V_{M} = 1.5 \text{ V} \text{ at } V_{CC} \ge 2.7 \text{ V};$ V_{M} = 0.5 \times V_{CC} at V_{CC} < 2.7 V;

 $V_{\mbox{OL}}$ and $V_{\mbox{OH}}$ are the typical output voltage drop that occur with the output load.

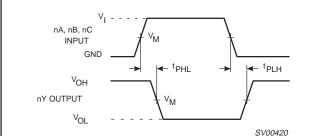


Figure 1. Input (nA, nB, nC) to output (nY) propagation delays.

TEST CIRCUIT

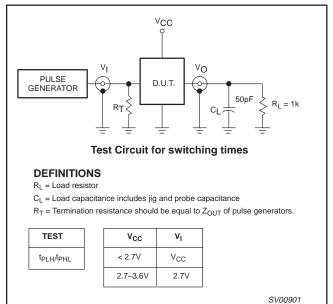
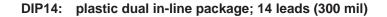
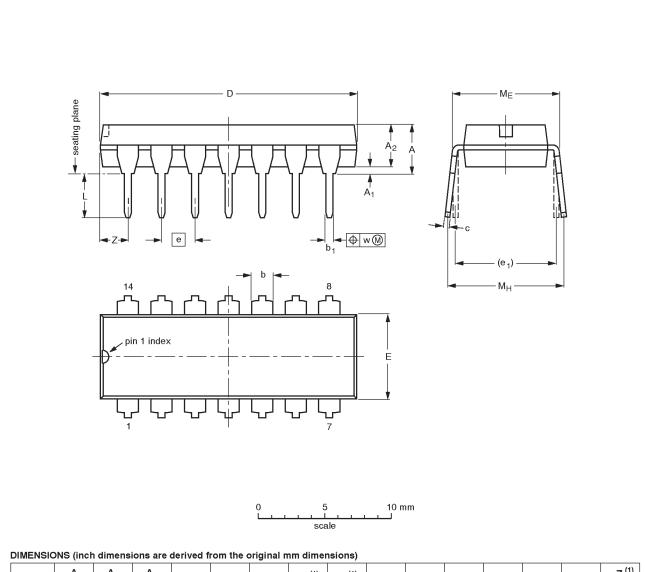


Figure 2. Load circuitry for switching times.





UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	с	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	ME	м _н	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

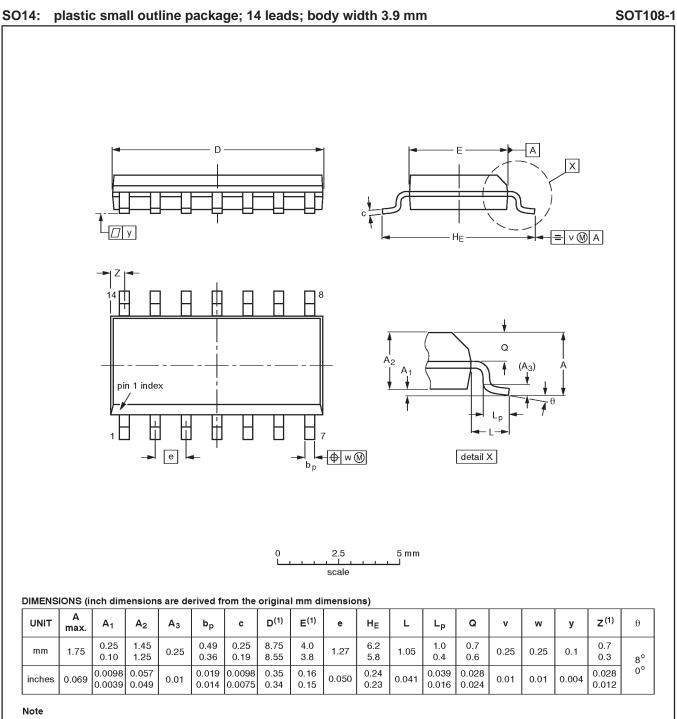
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VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT27-1	050G04	MO-001AA				-92-11-17 95-03-11

Product specification

SOT27-1

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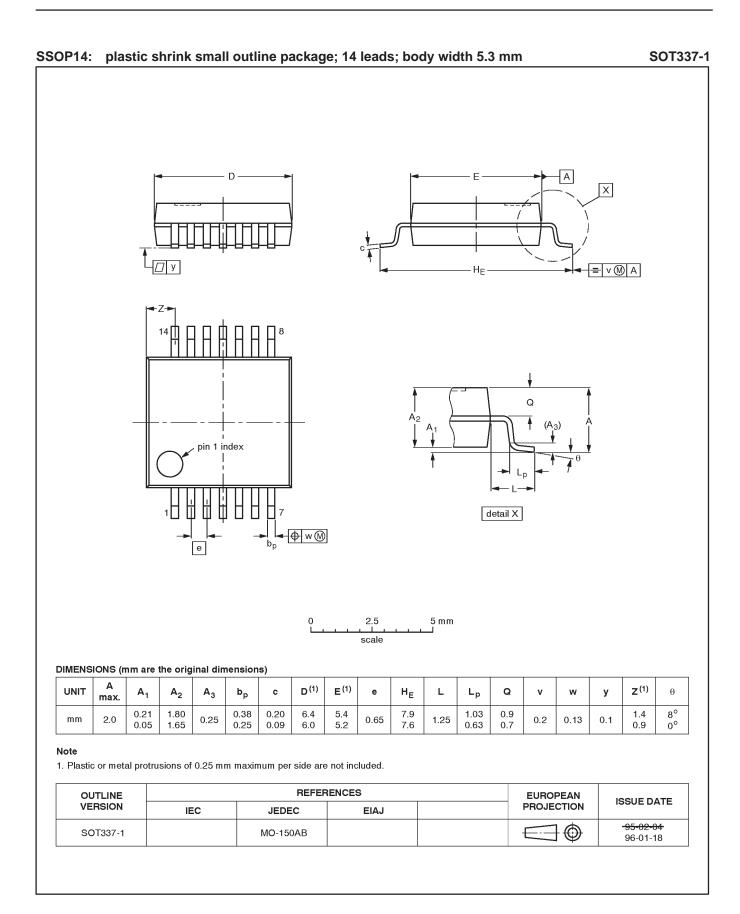
Product specification



1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT108-1	076E06S	MS-012AB				91-08-13 95-01-23

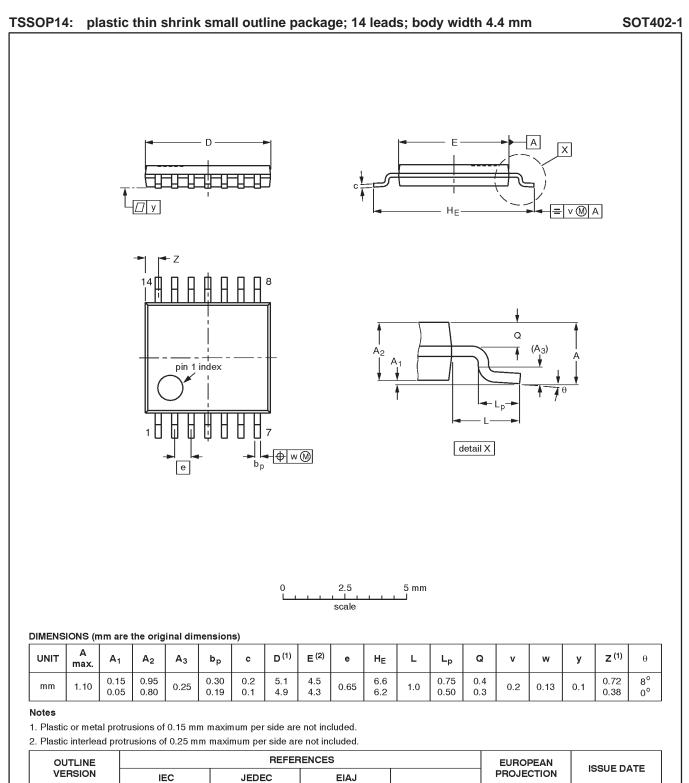
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DEFINITIONS		
Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
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